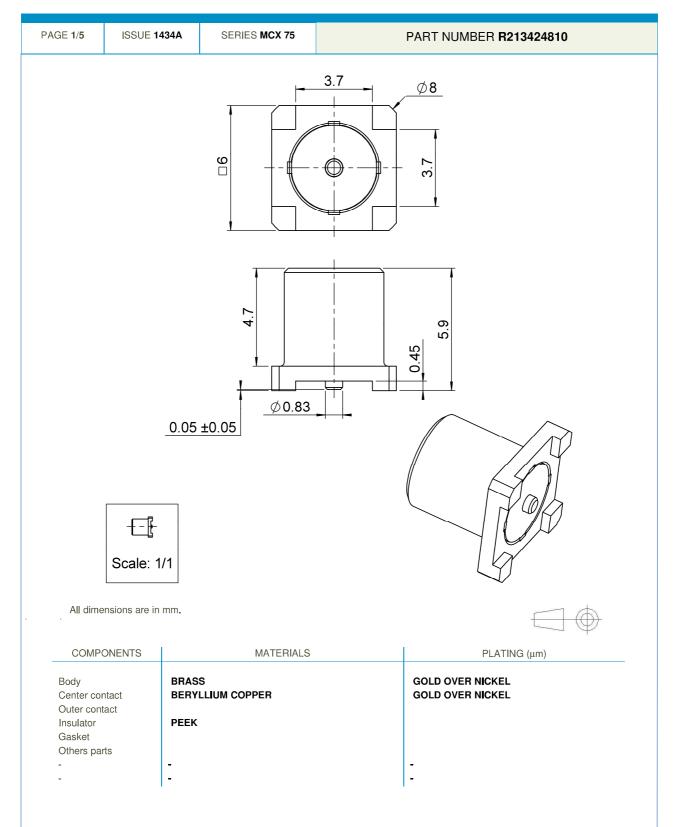


STRAIGHT JACK RECEPTACLE FOR PCB SMT TYPE - REEL OF 100





STRAIGHT JACK RECEPTACLE FOR PCB SMT TYPE - REEL OF 100

|--|

PACKAGING

100	Contact us	Contact us
Standard	Unit	Other

ELECTRICAL CHARACTERISTICS

Impedance 75 Frequency GHz

x F(GHz) Maxi √F(GHz) dB Maxi **VSWR** 1.25 0.000 Insertion loss 0.1 RF leakage NA - F(GHz)) dB Maxi Voltage rating 335 Veff Maxi

Dielectric withstanding voltage 1000 Veff mini Insulation resistance 1000 $M\Omega$ mini **ENVIRONMENTAL**

Operating temperature Hermetic seal -55/+155 °C Atm.cm3/s NA NA

Panel leakage

MECHANICAL CHARACTERISTICS

SPECIFICATION Center contact retention

Axial force – Mating End Axial force – Opposite end 10 N mini 10 N mini N.cm mini Torque NA

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini

Weight 0.530 g

OTHER CHARACTERISTICS

Others:

Packing complies with:

Assembly instruction:NA

IPC/JEDEC J-STD-033B.1 Level 3



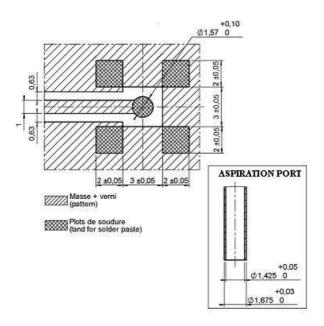
STRAIGHT JACK RECEPTACLE FOR PCB SMT TYPE - REEL OF 100

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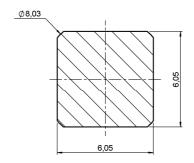
MCX SERIES - INFORMATION

Coplanar line: pattern and signal are on the same side. Thickness of PCB:.064(1.6mm)

The material of PCB is the epoxy resin of glass fabrics bacs . (Er = 4.8) . The solder resist should be printed exept for the land pattern on the PCB



SHADOW OF MCX RECEPTACLE FOR VIDEO CAMERA





STRAIGHT JACK RECEPTACLE FOR PCB SMT TYPE - REEL OF 100

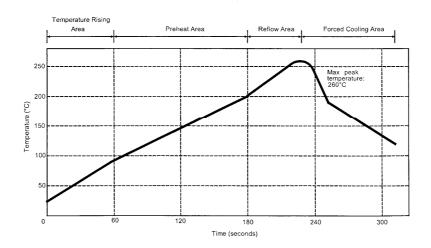
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SOLDER PROCEDURE

- 1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux. We advise a thickness of 150 microns (5.9 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.

 Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. Soldering by infra-red reflow.
 Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec



STRAIGHT JACK RECEPTACLE FOR PCB SMT TYPE - REEL OF 100

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